



#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max
	42mΩ @ V <sub>GS</sub> = 10V	4.6A
40V	52mΩ @ V <sub>GS</sub> = 4.5V	4.1A

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
  - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMN4035LQ)

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

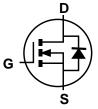
#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 ©3
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

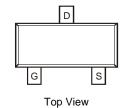


SOT23

Top View



Internal Schematic



Pin-Out

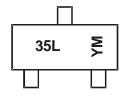
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN4035L-7	SOT23	3000/Tape & Reel
DMN4035L-13	SOT23	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



35L = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2019	20	20	2021	2022	20	23	2024	2025	20	26	2027
Code	G	H	1	I	J	ł	<	L	М	1	1	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	40	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V	
Continuous Drain Current (Note 6) Vgs = 10V	lD	4.6 3.7	А	
Maximum Body Diode Forward Current (Note 6)		Is	1.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	25	Α	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1	lsм	25	Α	

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation (Note 5)		PD	0.72	W
Thermal Resistance, Junction to Ambient (Note 5)  Steady State		Reja	171	°C/W
Power Dissipation (Note 6)		PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	93	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

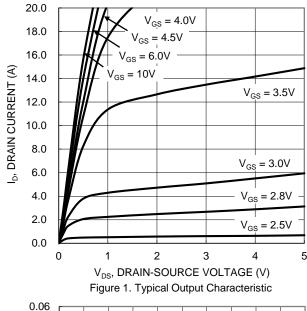
## **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

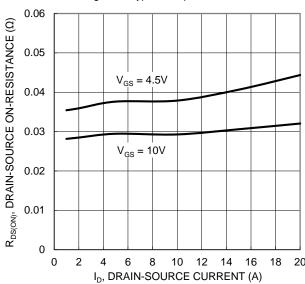
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			- 71			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40		_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	-	1	μΑ	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	V <sub>G</sub> S = ±20V, V <sub>D</sub> S = 0V
ON CHARACTERISTICS (Note 7)				•		
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	D	_	30	42	mΩ	V <sub>G</sub> S = 10V, I <sub>D</sub> = 4.3A
Static Drain-Source On-Resistance	RDS(ON)	_	40	52	11122	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.9A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.25A
DYNAMIC CHARACTERISTICS (Note 8)				•		•
Input Capacitance	Ciss	_	574	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz
Output Capacitance	Coss	_	87.8	_	pF	
Reverse Transfer Capacitance	Crss	_	38.7	_		
Gate Resistance	Rg	_	1.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.9	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	12.5	_	nC	V <sub>DS</sub> = 20V. I <sub>D</sub> = 3.9A
Gate-Source Charge	Qgs	_	1.7	_	iiC	VDS = 20V, ID = 3.9A
Gate-Drain Charge	Qgd	_	2.2	_		
Turn-On Delay Time	td(ON)	_	3.1	_		
Turn-On Rise Time	t <sub>R</sub>	_	2.6	_	20	$V_{DD} = 20V, V_{GS} = 10V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	15	_	ns	$R_L = 20\Omega, R_G = 6\Omega$
Turn-Off Fall Time	tF	_	5.5	_		
Reverse Recovery Time	t <sub>RR</sub>	_	6.5	_	ns	L 2.04 di/dt 5004/0-
Reverse Recovery Charge	$Q_{RR}$	_	1.2	_	nC	IF = 3.9A, di/dt = 500A/µs

Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.







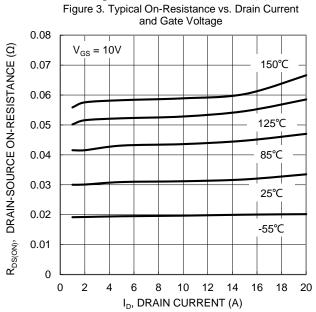


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

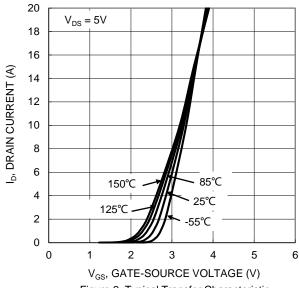
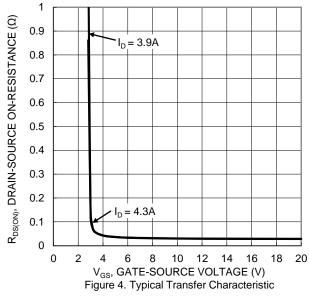


Figure 2. Typical Transfer Characteristic



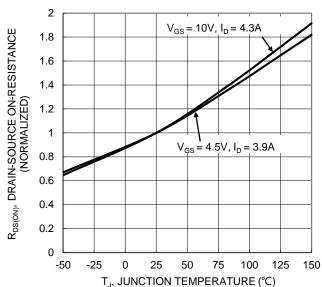
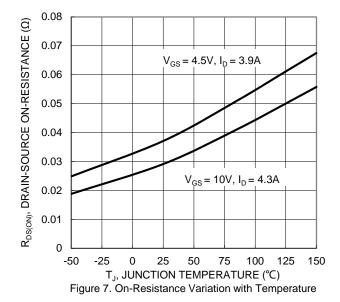
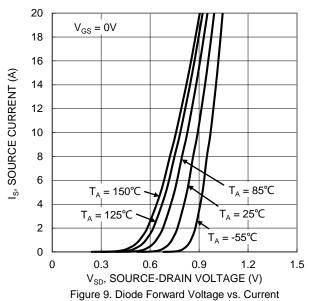
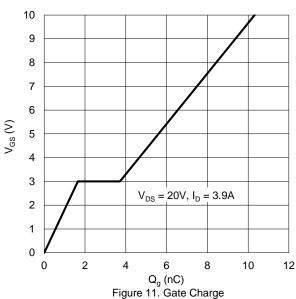


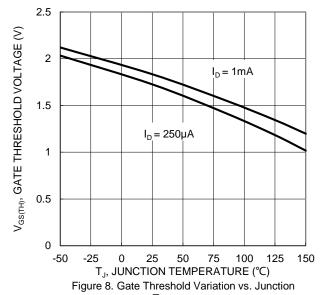
Figure 6. On-Resistance Variation with Temperature

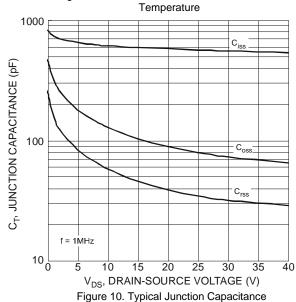


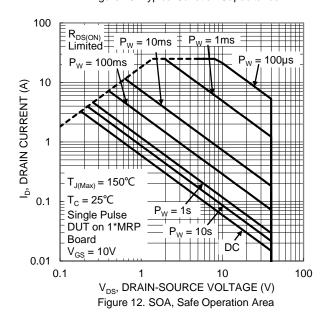














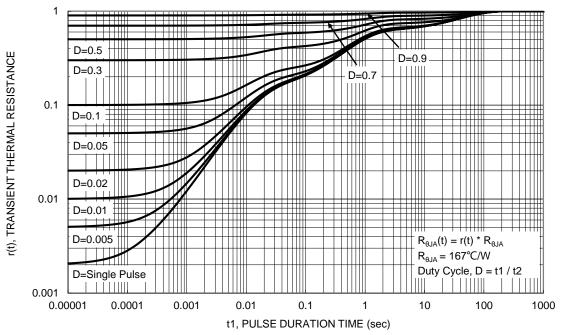


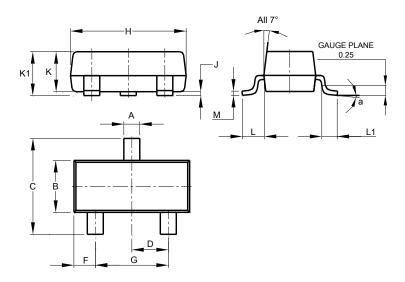
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23

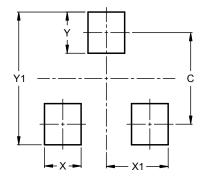


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	<b>a</b> 0° 8°						
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
С	2.0
X	0.8
X1	1.35
Y	0.9
V1	2.0



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